PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Hiroshi ABE	07/08/2008
Hideo SATO	07/09/2008

RECEIVING PARTY DATA

Name:	Sony Corporation 1-7-1 Konan, Minato-Ku	
Street Address:		
City:	Tokyo	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12211669

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	09812.1333
NAME OF SUBMITTER:	David W. Hill

Total Attachments: 2

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PATENT REEL: 021554 FRAME: 0306

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S08P1441US00 09812.1333

Docket Number:

WHEREAS, I, as a below named inventor, residing at the address only one name is listed below) or a joint inventor (if plural names are listed below BIOLOGICAL INFORMATION STORING APPARATUS, BIOLOGICAL AUTHORS	y) of certain new and useful improvements in HENTICATION APPARATUS, DATA
STRUCTURE FOR BIOLOGICAL AUTHENTICATION, AND BIOLOGICAL A	
for which application for Letters Patent of the United States of America was execut and address;	ed by me on the date indicated next to my name
AND WHEREAS, Sony Corporation, a Japanese corporation Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all intersaid application disclosing the invention and in, to and under any Letters Patent of therefor in the United States and in any and all foreign countries;	rest in, to and under said invention,
NOW THEREFORE, in consideration of the sum of One Dollar (\$\frac{3}{2}\$ the receipt and sufficience of which are hereby acknowledged, I, as a sole or joint is hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, an interest in the said invention, said application, including any divisions and continue Patent of the United States, and countries foreign thereto, which may be granted for rights and/or convention rights under the International Convention for the Protection of Relating to Patents, Designs and Industrial Models, and any other international again adheres, and to any other benefits accruing or to accrue to me with respect to the patents in the United States and countries foreign thereto, and I hereby authorize and said United States Letters Patent to said ASSIGNEE, as the assignee of the whole is	nventor as indicated below, by these presents do ad legal representatives, the entire right, title and ations thereof, and in and to any and all Letters said invention, and in and to any and all priority of Industrial Property, Inter-American Convention reements to which the United States of America filing of applications for patents or securing of request the Commissioner of Patents to issue the
And I further agree to execute all necessary or desirable and lawful futur ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal represent without further remuneration, in order to perfect title in said invention, mod applications and Letters Patent of the United States and countries foreign thereto;	esentatives may from time-to-time present to me
And I further agree to properly execute and deliver and without further rempapers for application for foreign patents, for filing subdivisions of said application reissues of any Letters Patent which may be granted for my aforesaid invention, as the prepare at its own expense;	n for patent, and or, for obtaining any reissue or
And I further agree that ASSIGNEE will, upon its request, be provided prelating to said application, said invention and said Letters Patent and legal equiva accessible to me and will testify as to the same in any interference or litigation relationship.	lents in foreign countries as may be known and
And I hereby covenant that no assignment, sale, agreement or encumbrance would conflict with this assignment and sale.	has been or will be made or entered into which
And I hereby authorize and request my attorney(s) of record in this application in the spaces that follow: Serial Number:	tion to insert the serial number and filing date of , Filing Date:
This assignment executed on the dates indicated below.	
Hiroshi ABE	Execution date of U.S. Patent Application
Name of first or sole inventor	Execution date of U.S. Patent Application
Tokyo, Japan	
Residence of first or sole inventor	
Hinoshi Abe	July 8, 2008 Date of this assignment
Signature of first and la inventor	Date of this assignment

ASSIGNMENT

PATENT REEL: 021554 FRAME: 0307

Hideo SATO	July 9, 2008 Execution date of U.S. Patent Application
Name of second inventor	Execution date of U.S. Patent Application
Tokyo, Japan	
Residence of second inventor	
	July 9, 2008 Date of this assignment
7 fides Sature Signature of second inventor	Date of this assignment
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Name of third inventor	Execution date of U.S. Patent Application
Residence of third inventor	
Signature of third inventor	Date of this assignment
Name of fourth inventor	Execution date of U.S. Patent Application
Residence of fourth inventor	
Signature of fourth inventor	Date of this assignment
Name of fifth inventor	Execution data of IIC Detant Application
name of fitth inventor	Execution date of U.S. Patent Application
Residence of fifth inventor	
Signature of fifth inventor	Date of this assignment

PATENT REEL: 021554 FRAME: 0308

RECORDED: 09/19/2008